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Electronic Filing System (EFS) Data
Electronic Patent Application Submission
USPTO Use Only

EFS ID: 43558
Application ID: 09738193
Title of Invention: System, Method and Apparatus
for Constructing a
Semiconductor Wafer-Interposer
Using B-Stage Laminates
First Named Inventor: John Pierce
Domestic/Foreign Application: Domestic Application
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Payment Category: Credit Card
Credit Card Number: *****2005
Expiration Date: 09302005
Card Holder Name: Lawrence R. Youst
Postal Code: 75230
RAM Payment Status: RAM success
RAM User ID: EFSPROD
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